

**TRANSMITTAL OF INFORMATION DISCLOSURE STATEMENT**  
(Under 37 CFR 1.97(b) or 1.97(c))

Docket No.  
SEC.1127

In Re Application Of: Mu-Kyeng JUNG et al.



Application No.	Filing Date	Examiner	Customer No.	Group Art Unit	Confirmation No.
10/824,399	April 15, 2004	Thao X. LE	20987	2418	5525

Title: SEMICONDUCTOR DEVICE INCLUDING METAL INTERCONNECTION AND METAL RESISTOR AND METHOD OF MANUFACTURING THE SAME

Address to:  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**37 CFR 1.97(b)**

1. ☐ The Information Disclosure Statement submitted herewith is being filed within three months of the filing of a national application other than a continued prosecution application under 37 CFR 1.53(d); within three months of the date of entry of the national stage as set forth in 37 CFR 1.491 in an international application; before the mailing of a first Office Action on the merits, or before the mailing of a first Office Action after the filing of a request for continued examination under 37 CFR 1.114.

**37 CFR 1.97(c)**

2. ☒ The Information Disclosure Statement submitted herewith is being filed after the period specified in 37 CFR 1.97(b), provided that the Information Disclosure Statement is filed before the mailing date of a Final Action under 37 CFR 1.113, a Notice of Allowance under 37 CFR 1.311, or an Action that otherwise closes prosecution in the application, and is accompanied by one of:

☒ the statement specified in 37 CFR 1.97(e);

OR

☐ the fee set forth in 37 CFR 1.17(p).

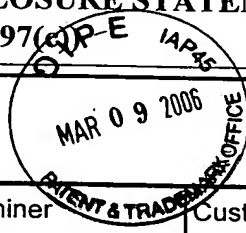
3. ☒ Also enclosed is a copy of a Taiwanese Preliminary Notice of the First Office Action dated January 27, 2006, which was issued in connection with Taiwanese Application No. 093112609, and an English-language translation thereof.

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**Payment of Fee**

(Only complete if Applicant elects to pay the fee set forth in 37 CFR 1.17(p))

- ☐ A check in the amount of \_\_\_\_\_ is attached.
- ☒ The Director is hereby authorized to charge and credit Deposit Account No. 50-0238 as described below.
- ☐ Charge the amount of \_\_\_\_\_
- ☐ Credit any overpayment.
- ☒ Charge any additional fee required.
- ☐ Payment by credit card. Form PTO-2038 is attached.

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(Date)

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Typed or Printed Name of Person Mailing Certificate

**\*This certificate may only be used if paying by deposit account.**  
Signature

Dated: March 9, 2006

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STATEMENT UNDER 37 CFR 1.97(e) ACCOMPANYING  
INFORMATION DISCLOSURE STATEMENT

Docket No.  
SEC.1127

In Re Application Of: Mu-Kyeng JUNG et al.

Application No. 10/824,399	Filing Date April 15, 2004	Examiner Thao X. LE	Customer No. 20987	Group Art Unit 2418	Confirmation No. 5525
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Invention: SEMICONDUCTOR DEVICE INCLUDING METAL INTERCONNECTION AND METAL RESISTOR  
AND METHOD OF MANUFACTURING THE SAME

COMMISSIONER FOR PATENTS:

This is a statement under the provisions of 37 CFR 1.97(e) in the above-identified application.

Check applicable statement herebelow:

Statement Under 37 CFR 1.97(e)(1)

- ☒ Each item of information contained in the accompanying Information Disclosure Statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of the Information Disclosure Statement.

Statement Under 37 CFR 1.97(e)(2)

- ☐ No item of information contained in the accompanying Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application, and, to the knowledge of the undersigned person, after making reasonable inquiry, no item of information contained in the accompanying Information Disclosure Statement was known to any individual designated in 37 CFR 1.56(c) more than three months prior to the filing of the Information Disclosure Statement.

  
Signature

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Dated: March 9, 2006

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CC:

# INFORMATION DISCLOSURE STATEMENT BY APPLICANT

## U. S. PATENT DOCUMENTS

## FOREIGN PATENT DOCUMENTS

**Examiner  
Signature**